

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Yoshihisa Nagano

Serial No.: 09/103,873

: Art Unit: : Examiner: 2815 G. Eckert II

Filed:

June 24, 1998

FOR: SEMICONDUCTOR N

METHOD FOR FABRICATING T

SUBMISSION OF SUBSTITUTE DECLARATION

Assistant Commissioner for Patents Washington, D.C. 20231

SIR:

Attached is a Substitute Declaration/Power of Attorney for the above-identified application. Entry of this Substitute Declaration/PowPECEIVE Attorney is respectfully requested.

Respectfally submitted,

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Enclosures: Substitute Declaration/Power of Attorney (3 pages)

Dated: November 16, 1998

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The Assistant Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. 18-0350 of any fees associated with this communication.

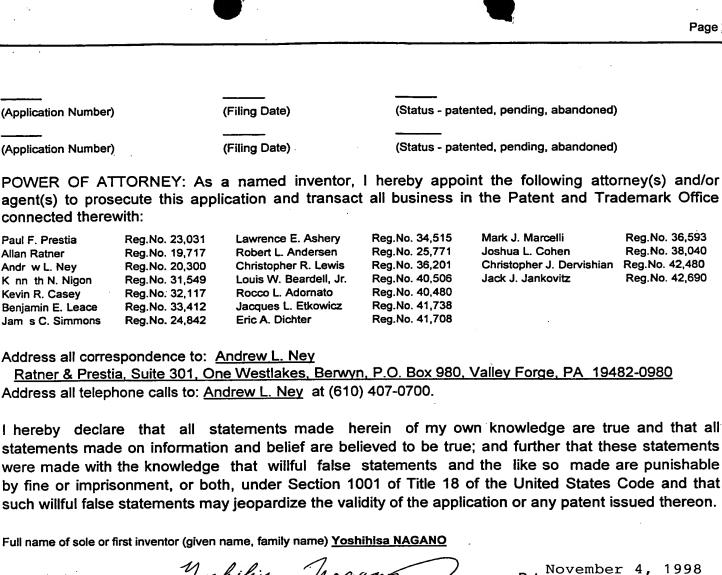
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C.

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Page <u>1</u> of 3

Declaration and Power of Attorney For Pat nt Application | NOV 1 9 1998 | English Languag D claration

Mut 1 3 1990			
As a below named inve	ntor, I hereby declare that:		
My residence, post offi	ce address and citizenship are	as stated below next to my r	name,
first and joint inventor (and for which a patent SEMICONDUCTOR D	nal, first and sole inventor (if or (if plural names are listed below is sought on the invention enti EVICE AND METHOD FOR FA ich is attached hereto unless th	v) of the subject matter which tled ABRICATING THE SAME,	or an original, is claimed
was filed on June	24, 1998 as		
	olication Number or PCT Intern d on (if applicable).	ational Application Number <u>0</u>	<u>9/103,873</u>
I hereby state that I ha	ve reviewed and understand the samended by any amendment	ne contents of the above iden treferred to above.	tified specification,
I acknowledge the duty 1.56.	y to disclose information which	is material to patentability as	defined in 37 CFR §
application(s) for pater designated at least or below by checking tl International applicatio Prior Foreign Applicatio	n priority benefits under 35 nt or inventor's certificate, or § ne country other than the Unithe box, any foreign applicate having a filing date before thon(s) Japan	365(a) of any PCT Internation ited States, listed below and tion for patent or inventor's tat of the application on which	onal application which I have also identified certificate, or PCT
<u>9-166991</u>		(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Moridiz real rifled)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the be listed below.	nefit under 35 U.S.C. § 119(e) of any United States pro RECE	visional application(s)
(Application Number)	(Filing Date)	NOV 2	3 1998
		GHOU	P 2100
(Application Number)	(Filing Date)		
I hereby claim the ber PCT International app			()



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NOV 2 3 1998

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Additional inventors ar being named on separately numbered sheets attached hereto.

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Seventh inventor's signature	Date			
Residence				
Citizenship	. •			
Post Office Address				
				